

DELPHI SERIES



FEATURES

- ♦ High efficiency: 91.7% @ 12V/10A
- ♦ Size:
 - 58.4mmx22.8mmx8.4mm
(2.30"x0.90"x0.33")
(Without heat-spreader)
 - 58.4mmx22.8mmx12.7mm
(2.30"x0.90"x0.50")
(With heat-spreader)
- ♦ Standard footprint
- ♦ Industry standard pin out
- ♦ Fixed frequency operation
- ♦ Input UVLO, Output OCP, OVP, OTP
- ♦ 2250V isolation
- ♦ Basic insulation
- ♦ No minimum load required
- ♦ ISO 9001, TL 9000, ISO 14001, QS 9000, OHSAS 18001 certified manufacturing facility
- ♦ UL/CUL 60950-1.

Delphi Series E48SC12010, Eighth Brick Family DC/DC Power Modules: 48V in, 12V/10A out

The Delphi Series E48SC12010, Eighth Brick, 48V input, single output, isolated DC/DC converter is the latest offering from a world leader in power systems technology and manufacturing -- Delta Electronics, Inc. This product family provides up to 120 watts, improved and very cost effective power solution of industry standard footprint and pinout. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performances, as well as extremely high reliability under highly stressful operating conditions. All models are fully protected from abnormal input/output voltage, current, and temperature conditions. The Delphi Series converters meet all safety requirements with basic insulation.

OPTIONS

- ♦ Negative/Positive on/off logic
- ♦ SMT or through-hole version

APPLICATIONS

- ♦ Telecom / Datacom
- ♦ Wireless Networks
- ♦ Optical Network Equipment
- ♦ Server and Data Storage
- ♦ Industrial / Testing Equipment

LUO LUOTECHNICAL SPECIFICATIONS

(T_A=25°C, airflow rate=300 LFM, V_{in}=48Vdc, nominal V_{out} unless otherwise noted.)

PARAMETER		NOTES and CONDITIONS		E48SC12010 (Standard)		
			Min.	Typ.	Max.	Units
ABSOLUTE MAXIMUM RATINGS						
Input Voltage						
Continuous					80	Vdc
Transient		100ms			100	Vdc
Operating Ambient Temperature			-40		85	°C
Storage Temperature			-55		125	°C
Input/Output Isolation Voltage					2250	Vdc
INPUT CHARACTERISTICS						
Operating Input Voltage			36		75	Vdc
Input Under-Voltage Lockout						
Turn-On Voltage Threshold			33	34	35	Vdc
Turn-Off Voltage Threshold			31	32	33	Vdc
Lockout Hysteresis Voltage			1	2	3	Vdc
Maximum Input Current		100% Load, 36Vin			4.3	A
No-Load Input Current				80		mA
Off Converter Input Current				10		mA
Inrush Current(I ² t)					1	A ² s
Input Reflected-Ripple Current		P-P thru 12μH inductor, 5Hz to 20MHz		20		mA
Input Voltage Ripple Rejection		120 Hz		60		dB
OUTPUT CHARACTERISTICS						
Output Voltage Set Point		Vin=48V, Io=Io.max, Tc=25°C	11.88	12.00	12.12	Vdc
Output Voltage Regulation						
Over Load		Io=Io,min to Io,max		±3	±15	mV
Over Line		Vin= 36V to 75V		±3	±15	mV
Over Temperature		Tc= -40°C to 85°C			±100	mV
Total Output Voltage Range		Over sample load, line and temperature	11.76		12.25	V
Output Voltage Ripple and Noise		5Hz to 20MHz bandwidth				
Peak-to-Peak		Full Load, 1μF ceramic, 10μF tantalum		40	120	mV
RMS		Full Load, 1μF ceramic, 10μF tantalum		15	25	mV
Operating Output Current Range			0		10	A
Output DC Current-Limit Inception		Output Voltage 10% Low	110		140	%
DYNAMIC CHARACTERISTICS						
Output Voltage Current Transient		48V, 10μF Tan & 1μF Ceramic load cap, 0.1A/μs				
Positive Step Change in Output Current		25% Io.max to 50% Io.max		200		mV
Negative Step Change in Output Current		50% Io.max to 25% Io.max		200		mV
Settling Time (within 1% Vout nominal)				200		μs
Turn-On Transient						
Start-Up Time, From On/Off Control				40	80	ms
Start-Up Time, From Input				40	80	ms
Maximum Output Capacitance		Full load; 5% overshoot of Vout at startup			2000	μF
EFFICIENCY						
100% Load		48Vin		91.7		%
60% Load		48Vin		91.9		%
ISOLATION CHARACTERISTICS						
Input to Output					2250	Vdc
Isolation Resistance			10			MΩ
Isolation Capacitance				1000		pF
FEATURE CHARACTERISTICS						
Switching Frequency				350	400	kHz
ON/OFF Control, Negative Remote On/Off logic						
Logic Low (Module On)		Von/off at Ion/off=1.0mA	-0.7		0.8	V
Logic High (Module Off)		Von/off at Ion/off=0.0 μA	3.5		12	V
ON/OFF Control, Positive Remote On/Off logic						
Logic Low (Module Off)		Von/off at Ion/off=1.0mA	-0.7		0.8	V
Logic High (Module On)		Von/off at Ion/off=0.0 μA	3.5		12	V
ON/OFF Current (for both remote on/off logic)		Ion/off at Von/off=0.0V			1	mA
Leakage Current (for both remote on/off logic)		Logic High, Von/off=12V			50	μA
Output Voltage Trim Range		Pout ≤ max rated power	-10%		10%	%
Output Voltage Remote Sense Range		Pout ≤ max rated power			10	%
Output Over-Voltage Protection		Over full temperature range	13.8	15.0	16.8	V
GENERAL SPECIFICATIONS						
MTBF		Io=80% of Io, max; 300LFM @25C		2.2		M hours
Weight		Without heat-spreader		21.4		grams
Weight		With heat-spreader		33.5		grams
Over-Temperature Shutdown	(Without heat spreader)	Refer to Figure 19 for Hot spot 1 location (48Vin,80% Io, 200LFM,Airflow from Vin+ to Vin-)		127		°C
Over-Temperature Shutdown	(With heat spreader)	Refer to Figure 21 for Hot spot 2 location (48Vin,80% Io, 200LFM,Airflow from Vin+ to Vin-)		118		°C



ELECTRICAL CHARACTERISTICS CURVES

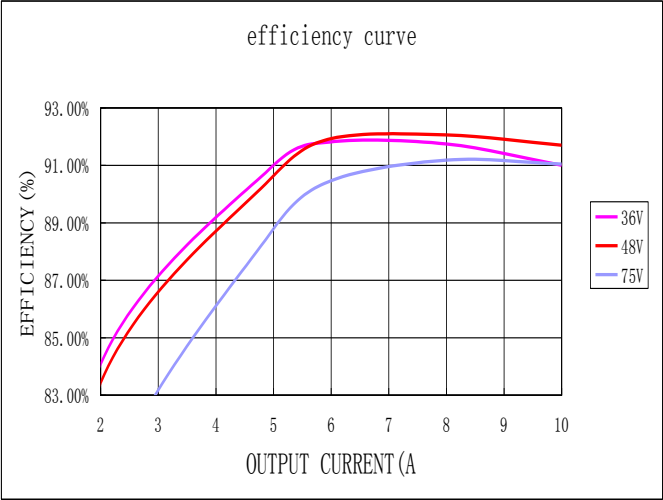


Figure 1: Efficiency vs. load current for 10A, minimum, nominal, and maximum input voltage at 25°C

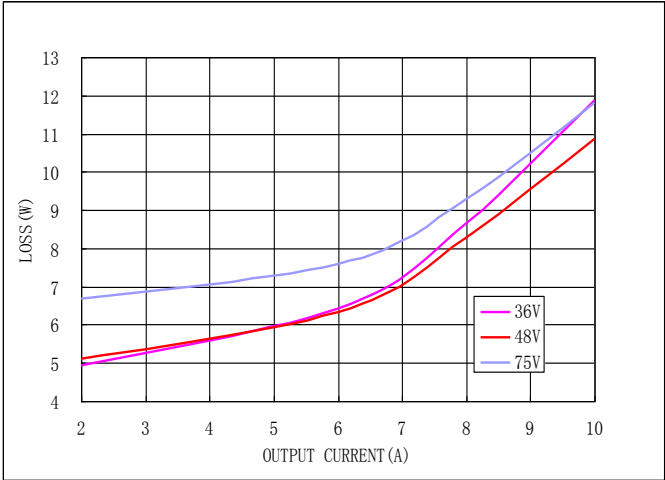


Figure 2: Power dissipation vs. load current for 10A, minimum, nominal, and maximum input voltage at 25°C.

b

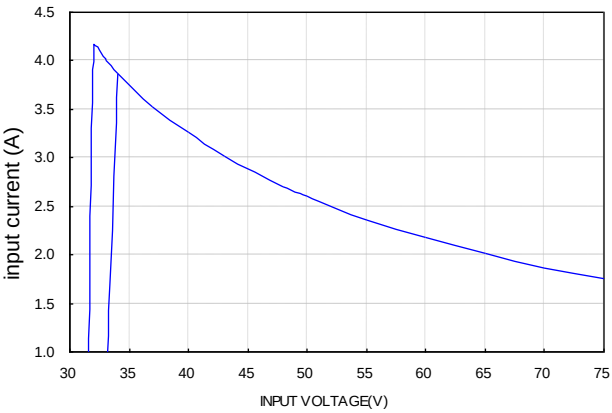


Figure 3: Typical full load input characteristics at room temperature



ELECTRICAL CHARACTERISTICS CURVES

For Negative Remote On/Off Logic

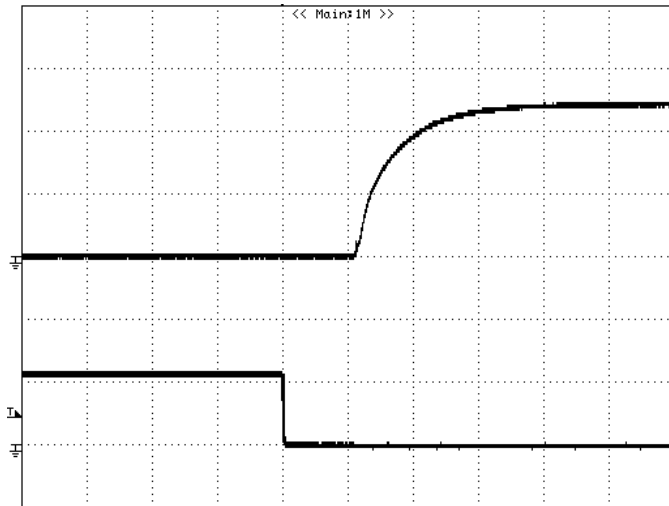


Figure 4: Turn-on transient at full rated load current (CC Mode load) (10ms/div). $V_{in}=48V$. Top Trace: V_{out} , 5V/div; Bottom Trace: ON/OFF input, 5V/div

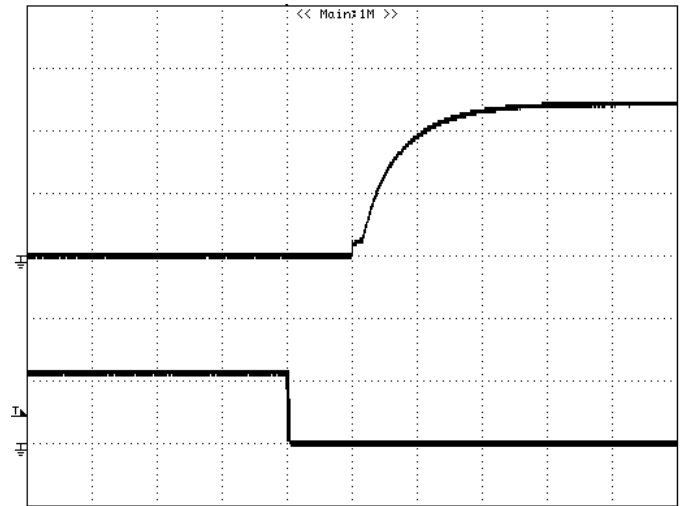


Figure 5: Turn-on transient at zero load current (10ms/div). $V_{in}=48V$. Top Trace: V_{out} , 5V/div; Bottom Trace: ON/OFF input, 5V/div

ELECTRICAL CHARACTERISTICS CURVES

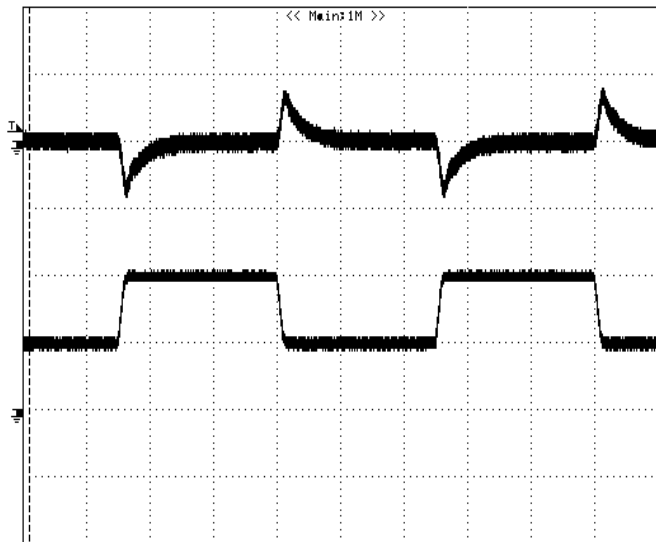


Figure 6: Output voltage response to step-change in load current (50%-25%-50% of I_o , max; $di/dt = 0.1A/\mu s$). Load cap: $10\mu F$, tantalum capacitor and $1\mu F$ ceramic capacitor. Top Trace: V_{out} (200mV/div, 200us/div), Bottom Trace: I_{out} (2A/div). Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module

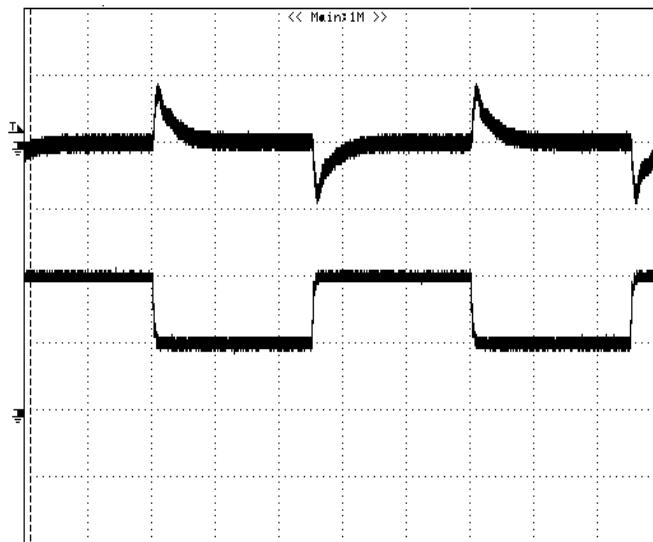


Figure 7: Output voltage response to step-change in load current (50%-25%-50% of I_o , max; $di/dt = 2.5A/\mu s$). Load cap: $10\mu F$, tantalum capacitor and $1\mu F$ ceramic capacitor. Top Trace: V_{out} (200mV/div, 200us/div), Bottom Trace: I_{out} (2A/div). Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module

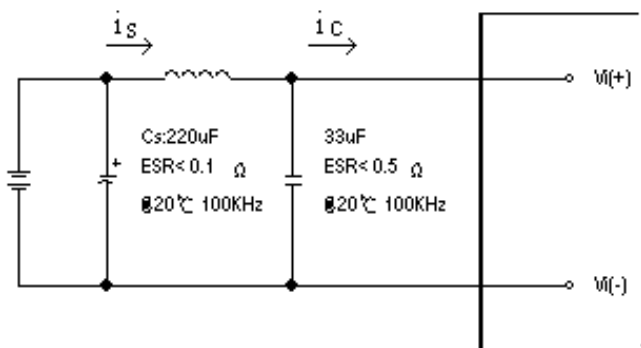


Figure 8: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

Note: Measured input reflected-ripple current with a simulated source Inductance (L_{TEST}) of $12\mu H$. Capacitor C_s offset possible battery impedance. Measure current as shown above



ELECTRICAL CHARACTERISTICS CURVES

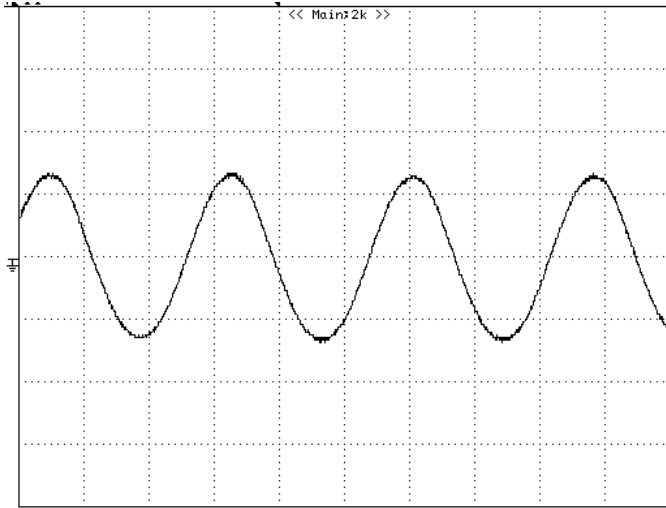


Figure 9: Input Terminal Ripple Current, i_c , at full rated output current and nominal input voltage with $12\mu\text{H}$ source impedance and $33\mu\text{F}$ electrolytic capacitor (100mA/div, 1us/div)

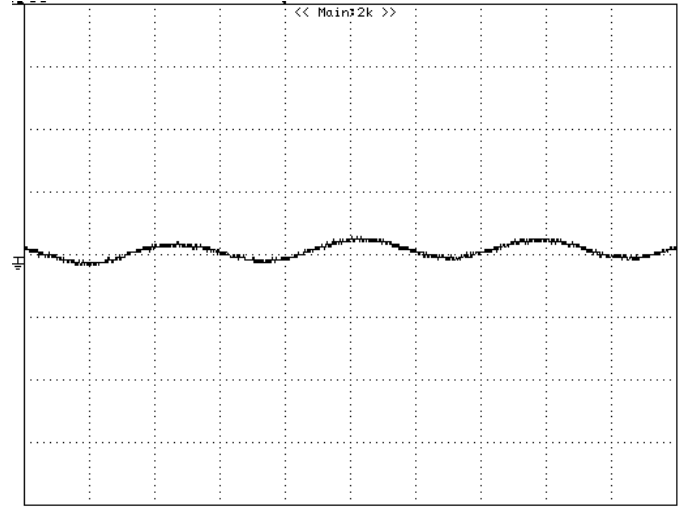


Figure 10: Input reflected ripple current, i_s , through a $12\mu\text{H}$ source inductor at nominal input voltage and rated load current (20mA/div, 1us/div)

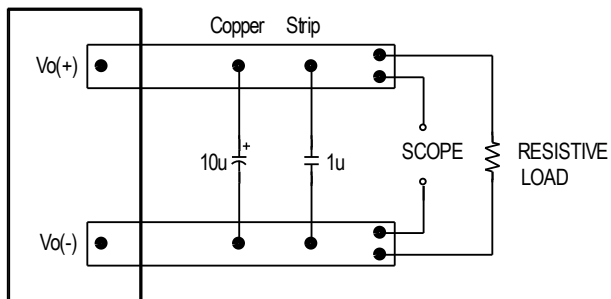


Figure 11: Output voltage noise and ripple measurement test setup

ELECTRICAL CHARACTERISTICS CURVES

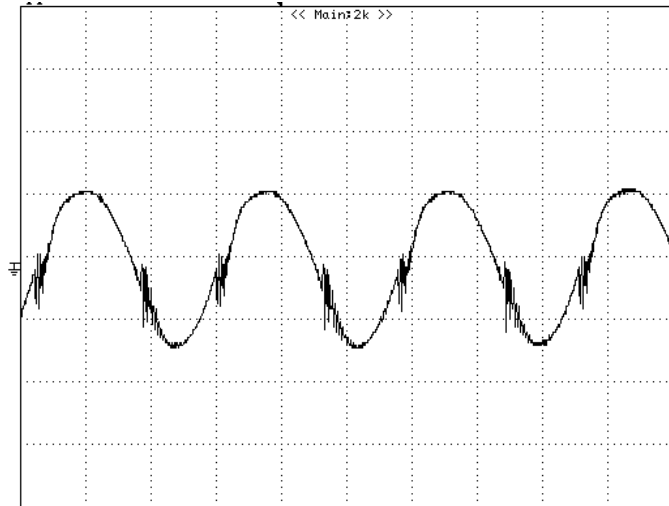


Figure 12: Output voltage ripple at nominal input voltage and rated load current ($I_o=10A$) (20mV/div, 1us/div)
Load capacitance: 1 μ F ceramic capacitor and 10 μ F tantalum capacitor. Bandwidth: 20 MHz. Scope measurements should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module

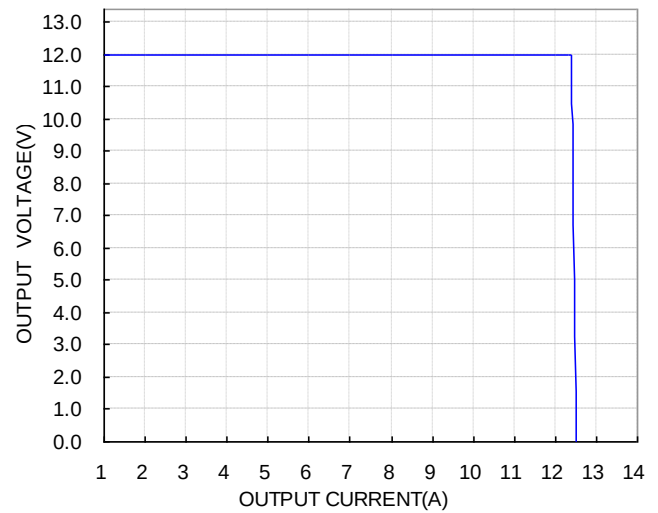


Figure 13: Output voltage vs. load current showing typical current limit curves and converter shutdown points

DESIGN CONSIDERATIONS

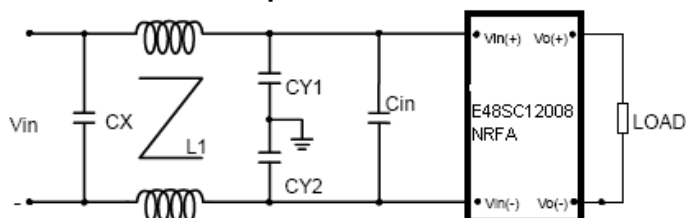
Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μH , we advise adding a 10 to 100 μF electrolytic capacitor ($\text{ESR} < 0.7 \Omega$ at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

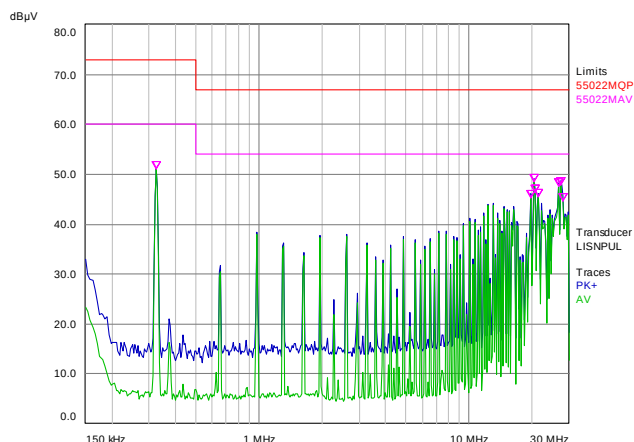
Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Application notes to assist designers in addressing these issues are pending release.

Schematic and components list



Cin is 100 μF low ESR Aluminum cap;
Cx is 2.2 μF ceramic cap;
CY1,CY2 are 22nF ceramic caps;
L1 is common-mode inductor, $L1=1.32\text{mH}$;

Test result: $V_{in}=48\text{V}$, $I_o=10\text{A}$,



Green line is quasi peak mode, blue line is average mode.

Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the

end-user's safety agency standard, i.e., UL60950-1, CSA C22.2 NO. 60950-1 2nd; IEC 60950-1 2nd:2005; and EN 60950-1 2nd: 2006+A11+A1, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a fuse with 12A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

FEATURES DESCRIPTIONS

Over-Current Protection

The modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. If the output current exceeds the OCP set point, the modules will automatically shut down (hiccup mode).

The modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the module will shut down (hiccup mode).

The modules will try to restart after shutdown. If the over voltage condition still exists, the module will shut down again. This restart trial will continue until the over voltage condition is corrected.

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will restart if the temperature is within specification.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi(-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to Vi(-). For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

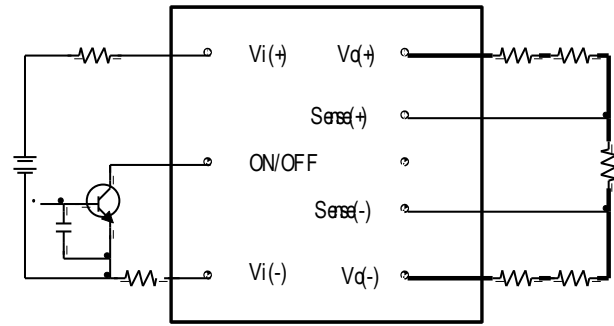


Figure 14: Remote on/off implementation

Remote Sense

Remote sense compensates for voltage drops on the output by sensing the actual output voltage at the point of load. The voltage between the remote sense pins and the output terminals must not exceed the output voltage sense range given here:

$$[Vo(+) - Vo(-)] - [SENSE(+) - SENSE(-)] \leq 10\% \times V_{out}$$

This limit includes any increase in voltage due to remote sense compensation and output voltage set point adjustment (trim).

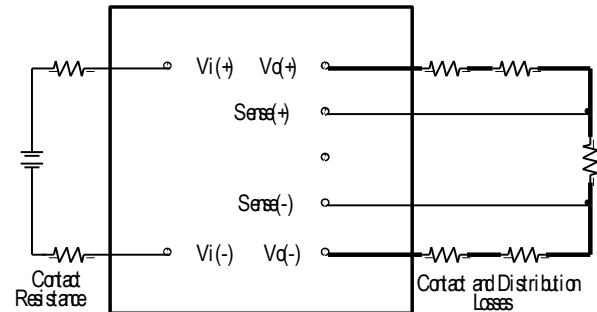


Figure 15: Effective circuit configuration for remote sense operation

If the remote sense feature is not used to regulate the output at the point of load, please connect SENSE(+) to Vo(+) and SENSE(-) to Vo(-) at the module.

The output voltage can be increased by both the remote sense and the trim; however, the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power does not exceed the maximum rated power.

FEATURES DESCRIPTIONS (CON.)

Output Voltage Adjustment (TRIM)

To increase or decrease the output voltage set point, the modules may be connected with an external resistor between the TRIM pin and either the SENSE(+) or SENSE(-). The TRIM pin should be left open if this feature is not used.

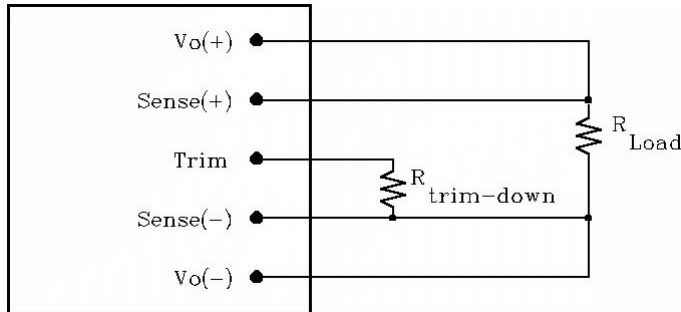


Figure 16: Circuit configuration for trim-down (decrease output voltage)

If the external resistor is connected between the TRIM and SENSE (-) pins, the output voltage set point decreases (Fig. 16). The external resistor value required to obtain a percentage of output voltage change $\Delta\%$ is defined as:

$$R_{trim-down} = \frac{511}{\Delta} - 10.2 (K\Omega)$$

Ex. When Trim-down -10%(12V×0.9=10.8V)

$$R_{trim-down} = \frac{511}{10} - 10.2 = 40.9 (K\Omega)$$

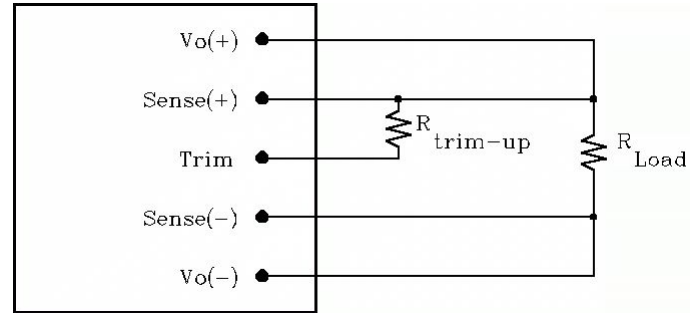


Figure 17: Circuit configuration for trim-up (increase output voltage)

If the external resistor is connected between the TRIM and SENSE (+) the output voltage set point increases (Fig. 17). The external resistor value required to obtain a percentage output voltage change $\Delta\%$ is defined as:

$$R_{trim-up} = \frac{5.11V_o(100 + \Delta)}{1.225\Delta} - \frac{511}{\Delta} - 10.2 (K\Omega)$$

Ex. When Trim-up +10%(12V×1.1=13.2V)

$$R_{trim-up} = \frac{5.11 \times 12 \times (100 + 10)}{1.225 \times 10} - \frac{511}{10} - 10.2 = 489.329 (K\Omega)$$

The output voltage can be increased by both the remote sense and the trim, however the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increase the output power of the module with the same output current.

Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power.

THERMAL CONSIDERATIONS

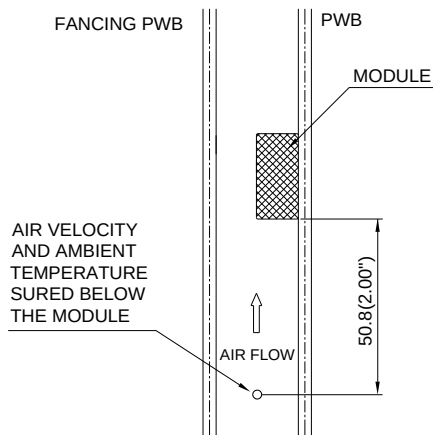
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a 185mmX185mm, 70µm (2Oz), 6 layers test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 18: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability; the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.

THERMAL CURVES (WITHOUT HEAT SPREADER)

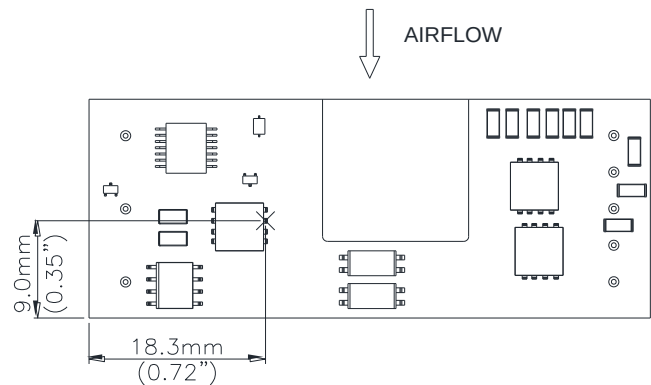


Figure 19: *Hot spot 1 temperature measured point.
The allowed maximum hot spot 1 temperature is defined at 122 °C

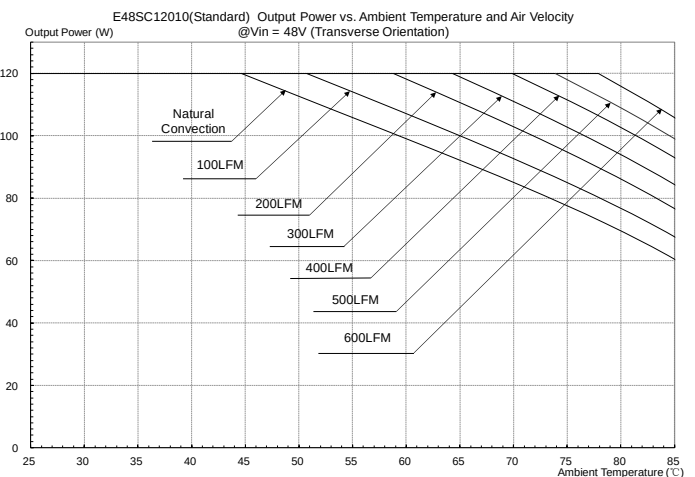


Figure 20: Output power vs. ambient temperature and air velocity @ Vin=48V(Transverse Orientation, airflow from Vin+ to Vin-, without heat spreader)

THERMAL CURVES (WITH HEAT SPREADER)

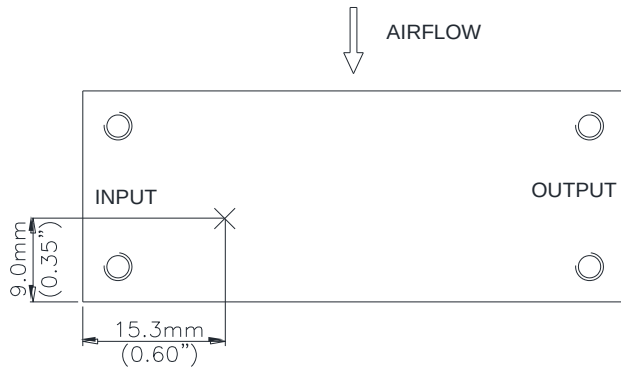


Figure 21: *Hot spot 2 temperature measured point.
The allowed maximum hot spot 2 temperature is defined at 105 °C

THERMAL CURVES (HEAT SPREADER ATTACH TO METAL CHASSIS)

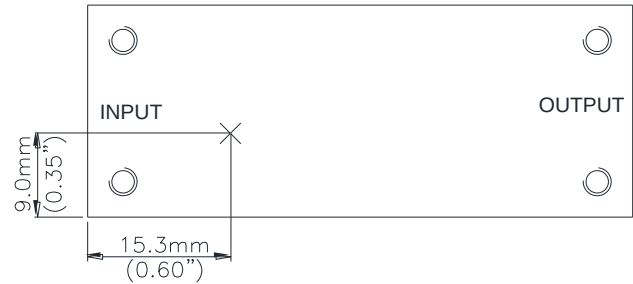


Figure 23: * Hot spot 3 temperature measured point

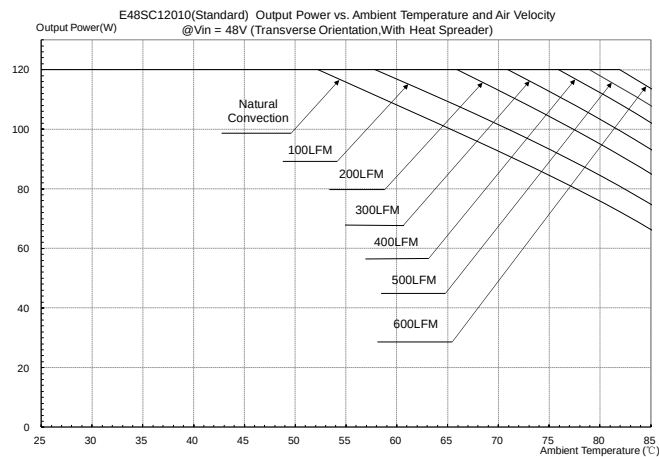


Figure 22: Output power vs. ambient temperature and air velocity @Vin=48V(Transverse Orientation, airflow from Vin+ to Vin-,with heat spreader)

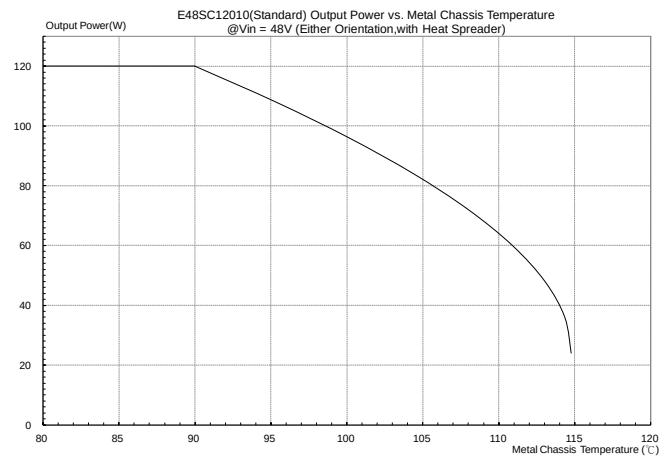
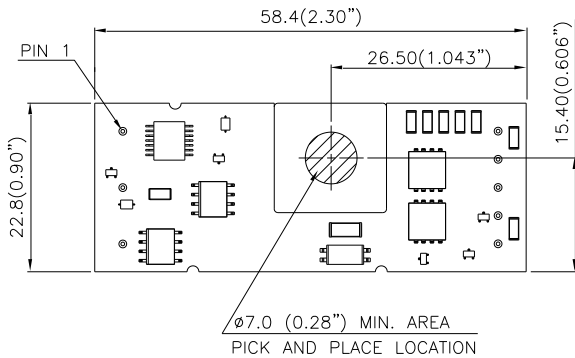


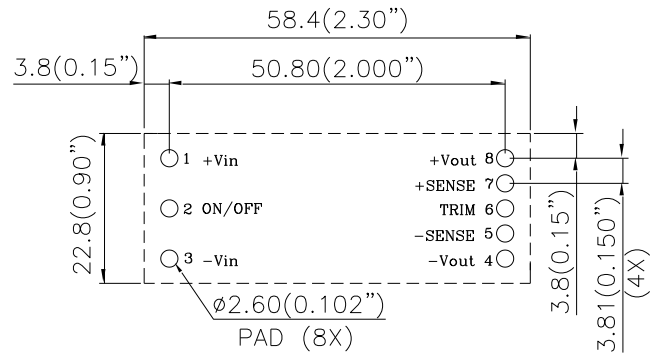
Figure 24: Output power vs. Metal chassis temperature @Vin=48V (Either orientation, with heat spreader)

PICK AND PLACE LOCATION(SMD)



NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

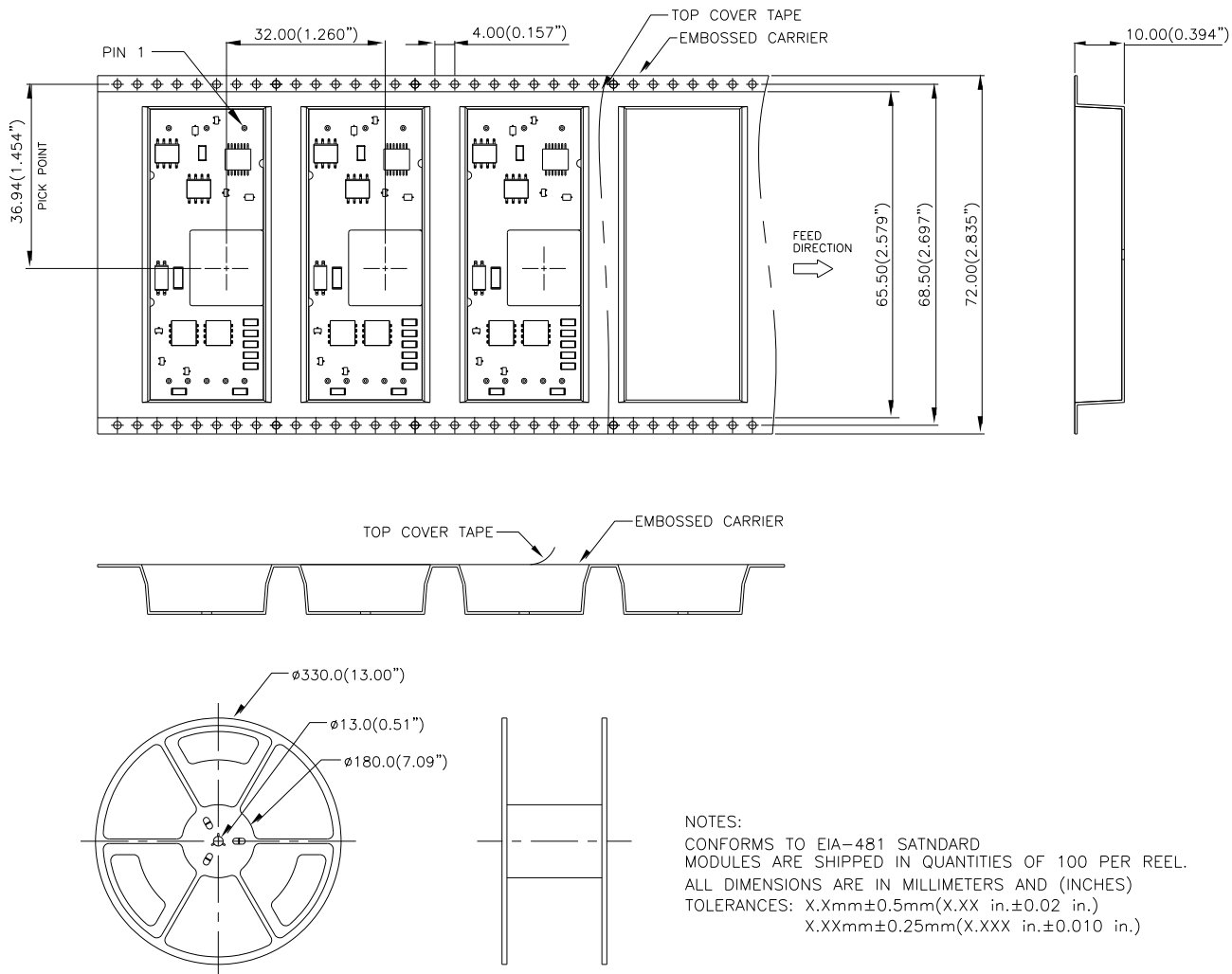
RECOMMENDED PAD LAYOUT (SMD)



RECOMENDED P.W.B. PAD LAYOUT

NOTES:
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

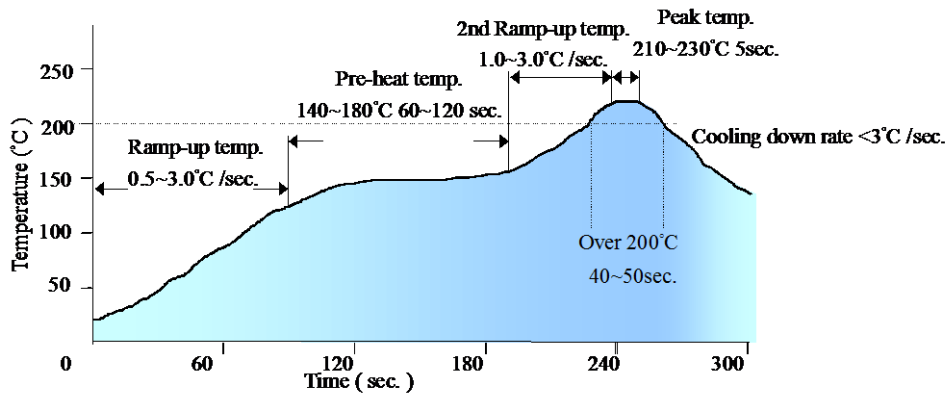
SURFACE-MOUNT TAPE & REEL



NOTES:
CONFORMS TO EIA-481 SATNDARD
MODULES ARE SHIPPED IN QUANTITIES OF 100 PER REEL.
ALL DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)
X.XXmm±0.25mm(X.XXX in.±0.010 in.)

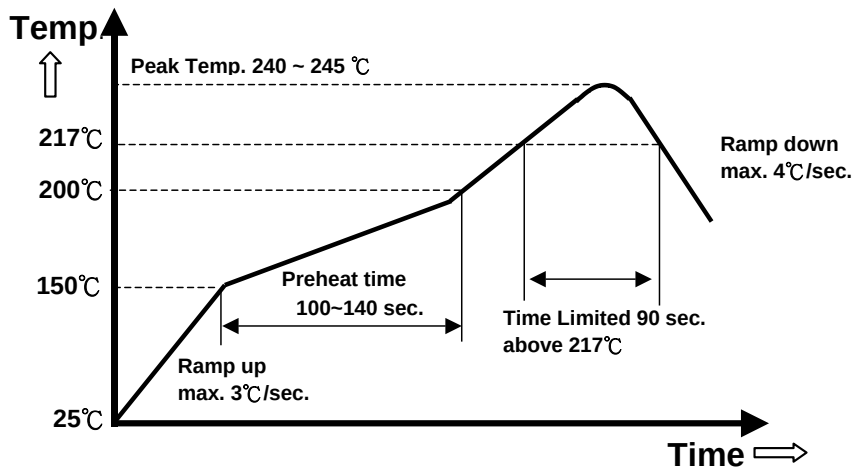


LEADED (Sn/Pb) PROCESS RECOMMEND TEMPERATURE PROFILE(SMD)



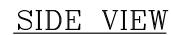
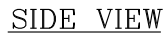
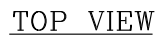
Note: The temperature refers to the pin of E48SC, measured on the pin +Vout joint.

LEAD FREE (SAC) PROCESS RECOMMEND TEMPERATURE PROFILE(SMD)



Note: The temperature refers to the pin of E48SC, measured on the pin +Vout joint.

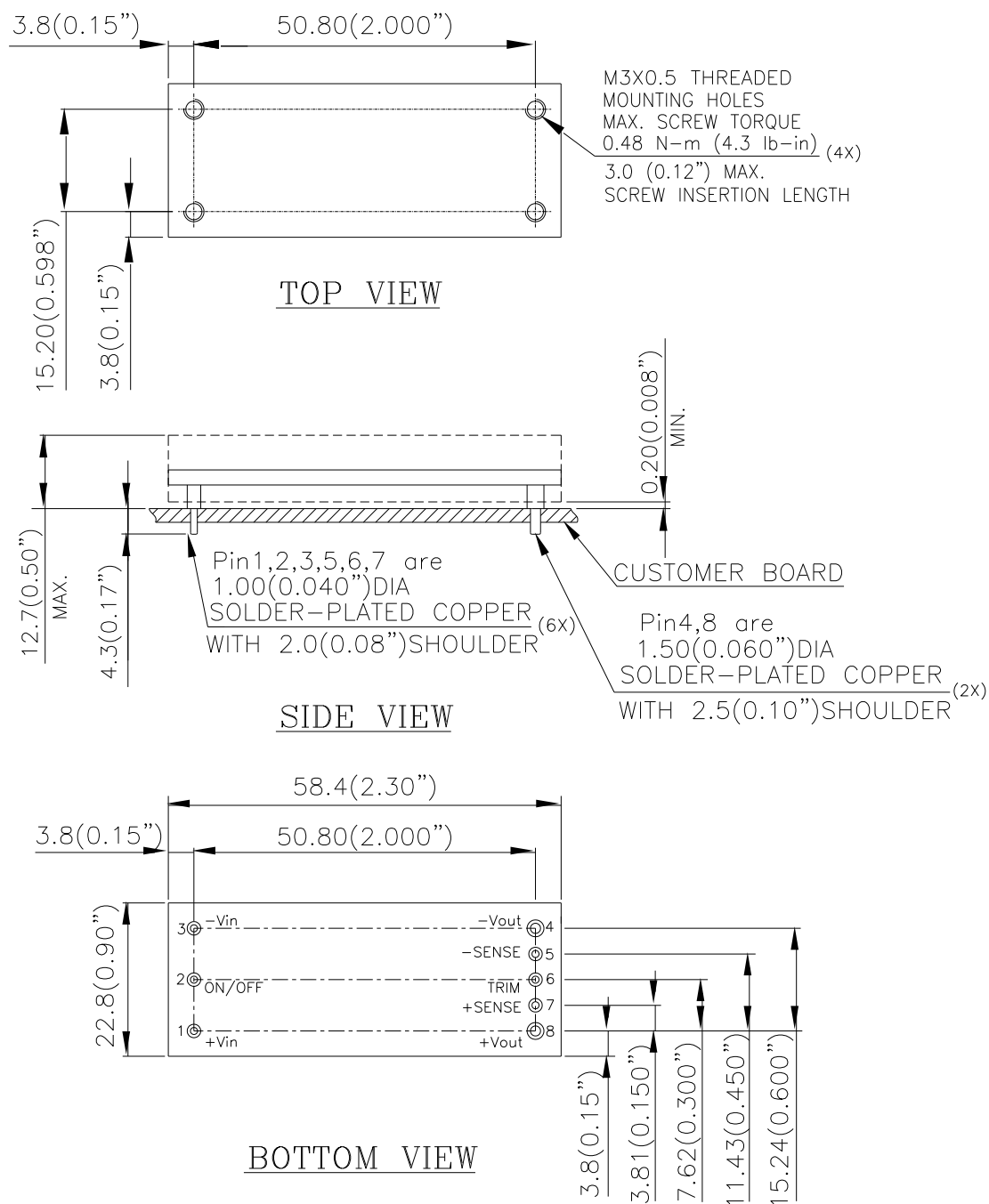
Surface-mount module



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MECHANICAL DRAWING(WITH HEAT-SPREADER)

***For modules with through-hole pins and the optional heat spreader, they are intended for wave soldering assembly onto system boards, please do not subject such modules through reflow temperature profile.**



NOTES:

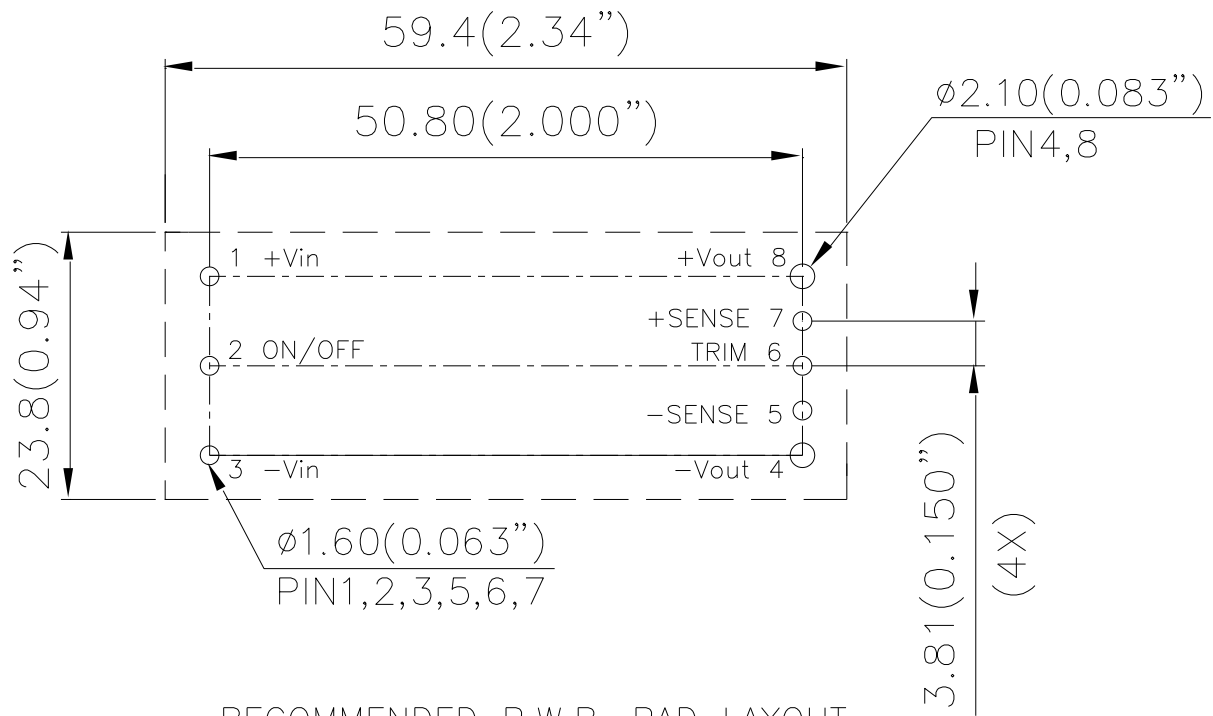
DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.)

X.XXmm±0.25mm(X.XXX in.±0.010 in.)

All pins are copper alloy with tin plated over Nickel under plating.

RECOMMENDED PAD LAYOUT



RECOMMENDED P.W.B. PAD LAYOUT

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: X.Xmm $\pm$ 0.5mm(X.XX in. $\pm$ 0.02 in.)

X.XXmm $\pm$ 0.25mm(X.XXX in. $\pm$ 0.010 in.)

PART NUMBERING SYSTEM

E	48	S	C	120	10	N	R	F	A
Type of Product	Input Voltage	Number of Outputs	Product Series	Output Voltage	Output Current	ON/OFF Logic	Pin Length/Type		Option Code
E- Eighth Brick	48 - 36~75V	S- Single	C- Improved E48SR series	120 - 12V	10A	N - Negative P - Positive	K - 0.110" N - 0.145" R - 0.170" C - 0.181" S - 0.189" T - 0.220" L - 0.248" M - SMD pin	F- RoHS 6/6 (Lead Free) Space - RoHS 5/6	A- Standard Functions H - with Heatspreader

MODEL LIST

MODEL NAME	INPUT		OUTPUT		EFF @ 100% LOAD
E48SC12010NRFH	36V -75V	4.3A	12V	10A	91.7%
E48SC12010NRFA	36V -75V	4.3A	12V	10A	91.7%

Default remote on/off logic is negative and pin length is 0.145"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales office.

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

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Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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